3W / 8.5V-18VDC / 36 Pin SSOP Package



FEATURES

- 3W isolated DC/DC converter
- Programmable asymmetrical output voltages
- 8.5 18VDC input voltage range
- IGBT/Si/SiC/Cascode GaN gate drive bias voltages
- 5kVAC/1min reinforced isolation
- 1.4kVDC working voltage
- High dV/dt immunity with 150kV/µs CMTI
- Full load 1.5W from -40°C to +120°C
- Less than 3.5pF isolation capacitance
- Compact 7.5x12.83mm SMD package
- 3 year warranty



Dimensions (LxWxH): $12.83 \times 7.5 \times 3.55$ mm (0.51 x 0.30 x 0.14 inch) 0.1g (0.0032 oz)

APPLICATIONS











SAFETY & EMC





DESCRIPTION

The R9C1T18/R 1.5W isolated DC/DC converter is a versatile solution designed for isolated gate bias voltages, particularly for transistors such as IGBTs, Si and SiC MOSFETs, and Cascode GaNs. This compact converter features a wide input voltage range of 8.5 - 18VDC and programmable asymmetrical output voltages, ensuring precise control and performance optimization for power electronics applications. With high 5kVAC/1min isolation, 1.4kVDC working voltage, high 150kV/µs CMTI, and remarkable stability up to 150°C (>0.5W), it offers superior reliability, even under harsh high power, high frequency switching environments. The ultra-low isolation capacitance, less than 3.5pF, ensures minimal noise propagation across the isolation barrier. All of these exceptional features are packaged in a compact 7.5 x 12.83mm SMD form factor, making it an ideal choice for all isolated gate bias voltage needs.

SELECTION GUIDE				
Part Number	Input Voltage Range [VDC]	Output Voltage Range ⁽¹⁾ [VDC]	Output Current max. [mA]	Efficiency typ. [%]
R9C1T18/R	8.5 - 18	$V_{OUT+} = 2.5 - 15.5$ $V_{OUT-} = (-2.5) - (-15.5)^{(2)}$ $V_{TOTAL} = 15 - 18$	$I_{OUT+} = +100 \text{mA}$ $I_{OUT-} = -12 \text{mA}$	52

Note1: V_{OUT+} and V_{OUT-} can be set from 2.5VDC to 15.5VDC or -2.5VDC to -15.5VDC respectively but the total

must be within the range of 15VDC to 18VDC. For more information see "Typical Application" below.

Note2: For V_{OUT}- between 0V and -2.5V please contact techsupport@recom-power.com

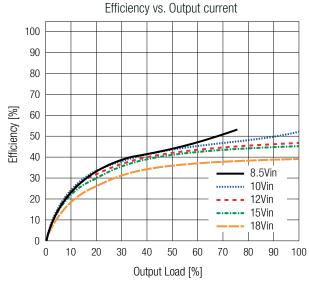


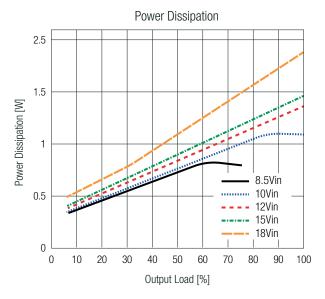


ABSOLUTE MAXIMUM RATINGS (measured @ T _{AMB} = 25°C, nom. V _{IN} , full load and after warm-up unless otherwise stated)					
Parameter	Symbol	Min.	Тур.	Max.	
	$V_{\mathbb{N}}$ to PGND	-0.3VDC		32VDC	
Absolute maximum voltage	CTRL, PG to PGND	-0.3VDC		7VDC	
	$V_{\text{out+}},$ COM, FBV $_{\text{out+}},$ FBV $_{\text{out-}}$ to $V_{\text{out-}}$	-0.3VDC		32VDC	
Maximum internal power losses ⁽³⁾	$T_{AMB} = +25^{\circ}C$			2.45W	
Maximum output power	$V_{TOTAL} = V_{OUT+}$ to $V_{OUT-}, T_{AMB} = +25^{\circ}C$			2.5W	
Junction Temperature		-40°C		+150°C	
Storage Temperature		-65°C		+150°C	

Note3: Exceeding maximum allowable power dissipation causes the device to enter thermal shut down which protects the device from permanent damage.

Parameter	Symbol	Condition	Min.	Min. Typ.	
Input Voltage Range	V _{IN}	refer to "Derating Graph"	8.5VDC	15VDC	18VDC
Lindon Voltago Lagrent (LIVI O)		rising	7.8VDC	8.2VDC	8.5VDC
Under Voltage Lockout (UVLO)		falling	7VDC	7.4VDC	7.7VDC
Over Voltage Lockout (OVLO)		rising	11.4VDC	22VDC	23.1VDC
		falling	19VDC	20VDC	21VDC
Soft Start Time				3ms	
Standby Current	ΙQ	V_{CTRL} = 5VDC, V_{IN} = 8VDC to 18VDC, no load			40mA
Quiescent Current		V _{CTRL} = 0VDC, V _{IN} = 8VDC to 18VDC			600µA
Output Power					1.5W
Power Dissipation		refer to "Power Dissipation"			2.36W
Switching Frequency		V _{IN} = 15VDC		15MHz	





REGULATIONS							
Parameter	Symbol	Condition	Min.	Тур.	Max.		
Feedback Voltage ⁽⁴⁾	V	$FBV_{\text{OUT+}}$ or $FBV_{\text{OUT-}}$ to $V_{\text{OUT-}}$	OVDC	2.5VDC	5.5VDC		
	V _{FB}	$V_{\mbox{\tiny OUT+}}$ to $V_{\mbox{\tiny OUT-}}$ in regulation	2.4675VDC	2.5VDC	2.5325VDC		
Feedback V _{OUT+} Hysteresis		hysteresis at the $FBV_{\text{\tiny OUT+}}$ pin	9mV	10mV	12.3mV		
Output Voltage Accuracy		0.1% of FB resistors	-1.3%		1.3%		

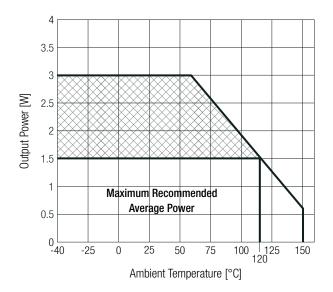
Note4: For isolated gate driver applications, one positive and one negative output are needed. In this case, V_{OUT+} to V_{OUT-} is the total output voltage, and the middle point becomes the reference point. Because the total voltage between V_{OUT+} and V_{OUT-} is always regulated through the FBV_{OUT+} feedback, the COM pin only must regulate the middle point voltage so that it can give the correct positive and negative voltages. The COM control is achieved through FBV_{OUT-} pin as described in "Adjustability" section.

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BASIC CHARACTERISTICS (measured @ T_{AMB}= 25°C, nom. V_{IN}, full load and after warm-up unless otherwise stated)

Derating Graph



Note5: Exceeding maximum allowable power dissipation causes device to enter thermal shutdown

which protects device from permanent damage.

Note6: Keep the average power at 1.5W max. or peak power 3W for 5 seconds max.

Note7: Test with Recom 50x50mm standard EVM board with 70µm copper, double layer

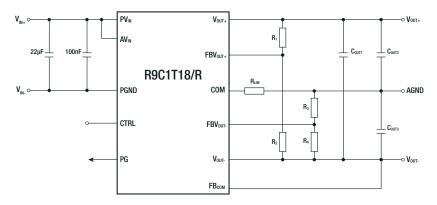
ADJUSTABILITY							
Parameter	Condition	Min.	Тур.	Max.			
Output Voltage Trimming	V _{our+} to V _{our-}	15VDC		18VDC			
	AGND to V _{OUT-}	2.5VDC		V _{OUT+} to V _{OUT-}			

The R9C1T18/R module creates two regulated outputs. It can be configured as a single output converter, V_{OUT-} to V_{OUT-} only, or a dual-output converter, V_{OUT-} to V_{OUT-} and COM to V_{OUT-} . Even though the module uses V_{OUT-} as the reference point to create two positive output voltages, the outputs can use COM as the reference point and become a positive and a negative output.

These two outputs are controlled independently through hysteresis control. Furthermore, the V_{OUT-} to V_{OUT-} is the main output, and COM to V_{OUT-} uses the main output as its input to create a second regulated output voltage.

Typical Application

 V_{TOTAL} = 15-18VDC, P_{MAX} = 1.5 watts



Example

To set the device into dual configuration, for example to +13/-5V, start to define main output voltage as the sum of both desired voltages (13VI + I-5VI) = 18V). 18V are V_{OUT+} to V_{OUT-} . Then set the negative output.

+13/-5 V_{TOTAL}= 18VDC, V_{OUT-}= -5VDC

+15/-3 V_{TOTAL}= 18VDC, V_{OUT}-= -3VDC

+12/-5 V_{TOTAL}= 17VDC, V_{OUT}-= -5VDC

Note8: Set V_{TOTAL} first and afterwards V_{OUT-} , V_{TOTAL} must be between 15VDC and 18VDC

Rev. 1-2024

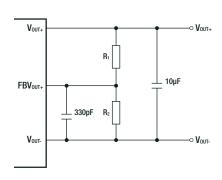
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TRIM FUNCTION

Setting the Main Output - Single Configuration

The V_{0UT+} to V_{0UT-} output is the primary module output, regulated by the sensed voltage on FBV_{0UT+} pin. The V_{0UT+} to V_{0UT-} voltage is sensed through a voltage divider (R1 and R2). When FBV_{0UT+} voltage is below the turn-off threshold (approx. 10mV above the 2.5V reference), the power stage operates, raising the output voltage. Once the output reaches the turn-off threshold, the power stage turns off, causing the voltage to drop due to load current. When the output voltage falls below the turn-on threshold (approx. 10 mV below the 2.5V reference), the power stage is reactivated. Precise voltage reference and hysteresis control ensure accurate regulation. For enhanced noise immunity, add a 330pF capacitor between FBV_{0UT+} and V_{0UT-} pins, avoiding excessive capacitance to prevent output voltage ripple or stability issues. If only a single output is required, connect FBV_{0UT+} to FBV_{0UT+} and leave COM pin open.



Calculation

$$R_1 = \frac{(V_{OUT+} - V_{ref})}{V_{ref}} \times R_2$$

Example

$$R_1 = \frac{(18V - 2.5V)}{(2.5V)} \times 11k\Omega = 68k2\Omega$$

Recommended resistor values for common V_{OUT+}:

V _{OUT+} [VDC]	$R_2[\Omega]$	$R_1[\Omega]$
15		54k9
16	441,	59k
17	11k	63k4
18		68k1

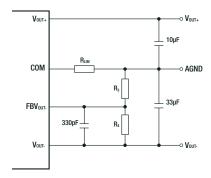
*(according to E96)

Setting the Second Output - Dual Configuration

For isolated gate drivers, V_{OUT+} to V_{OUT-} provides the regulated total voltage with the midpoint as the reference. The COM pin regulates the midpoint voltage for accurate positive and negative outputs based on FBV_{OUT+} feedback.

In Figure below, COM to V_{OUT-} is monitored through R3 and R4 on FBV_{OUT-}. A 330pF capacitor on FBV_{OUT-} filters noise. Charging resistor activation, controlled by FBV_{OUT-}, raises COM to V_{OUT-} voltage. After reaching the stop charging threshold, the charging resistor turns off. The discharge resistor, with a 20mV hysteresis, is then controlled by FBV_{OUT-}.

The COM to V_{OUT} regulator protects against prolonged high-side FET activation during a COM to V_{OUT} short. It monitors COM pin voltage, adjusting the high-side FET duty ratio. If COM pin voltage is below 0.645V while FBV_{OUT} is under 2.48V, a 20% duty ratio control overrides normal hysteresis. When COM pin voltage exceeds 0.73V, duty ratio control is disabled, and normal operation resumes.



Calculation

$$R_3 = \frac{(V_{OUT-} - V_{ref})}{V_{ref}} \times R_4$$

Example

$$R_3 = \frac{(5V - 2.5V)}{2.5V} \times 49k9\Omega = 49k9\Omega$$

Recommended resistor values for common V_{OUT}.:

V _{OUT-} [VDC]	$R_4[\Omega]$	$R_3[\Omega]$
3		10k
4	49k9	30k1
5		49k9

*(according to E96)

Note9: To achieve -2.5V on the V_{OUT} , output remove R4 and use a value between $10k\Omega$ and $100k\Omega$ for R3.

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CAPACITOR SELECTION

For CIN place a 10-µF or more and a 0.1-µF high-frequency decoupling capacitor in parallel close to VIN pins. A capacitance greater than 10µF can be used to reduce the voltage ripple when the series impedance from the voltage source to the VIN pins is large. For COUT1 add a 2.2µF or more and a 100nF capacitor for high-frequency decoupling of VOUT+ to VOUT-. Place the capacitors close to the VOUT+ and VOUT- pins. A capacitance greater than 2.2µF can be used to reduce the output voltage ripple. The selection of COUT2 and COUT3 is based on the gate charge requirement for the gate driver load, the charge balancing during the start-up, and the expected maximum current loading. COUT2 and COUT3 capacitors should be placed close to the load. Calculate COUT2 first.

Minimal COUT2 Calculation

$$C_{out2} = \frac{Q}{V_{out+} * \frac{V_{pp}}{100}}$$

Parameter		Unit
Q	gate charge	nC
V _{PP}	accepted Ripple	%
$V_{\text{OUT+}}$	output voltage +	VDC

Recommended COUT2 value is about 10 times higher than the calculated minimum. For simplification, it is recommended to use values for COUT2 between 2.2uF and 10uF. Use the following simplified formula to calculate minimal value of COUT3:

$$C_{out3} = \frac{V_{out+}}{V_{out-}} \times 1.1 \times C_{out2}$$

Example +15/-3 Outputs

$$c_{out2} = \frac{55nC}{15V * \frac{1\%}{100}} = 0.366 \mu F$$
 selected COUT2 = 4.7 μ F

Parameter		Value
Q	gate charge	55nC
V_{PP}	accepted Ripple	1%
V _{OUT+}	output voltage +	15VDC
V _{OUT-}	output voltage -	3VDC

$$c_{out3} = \frac{V_{out+}}{V_{out-}} \times 1.1 \times Cout2$$

$$C_{out3} = \frac{15VDC}{3VDC} \times 1.1 \times 4.7 \mu F = 25.85 \mu F$$
 user selected COUT3 = 3x10 μ F

CIN	min. COUT1 (VOUT+ to VOUT-)	VOUT+ to COM	VOUT- to COM	recommended COUT2	recommended COUT3
10μF + 100nF	2.2μF + 100nF	12VDC	5VDC	4.7μF	15µF
10μF + 100nF	2.2μF + 100nF	15VDC	3VDC	4.7μF	3x10μF

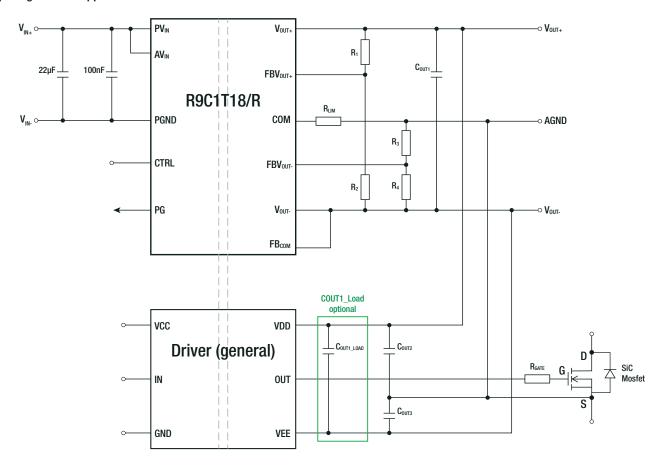
(V_{OUT+}V_{OUT+})*1.1 defines the minimal COUT3 to COUT2 ratio. Consider all capacitace connected to VOUT+ to COM in the system as COUT2 and then calculate the minimal COUT3. If COUT3 in the system is lower than the calculated minimum, the device may not start.

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CAPACITOR SELECTION

Typical gate drive application



In order to reduce the number of capacitors needed for COUT2 and COUT3, an additional capacitor COUT1_LOAD can be added at the load (driver circuit in the figure above) between VOUT+ and VOUT- rails.

COUT1_LOAD value [uF]	COUT2 value [%]	COUT3 value [%]
Not used	100%	100%
4.7uF	60%	60%
10uF	40%	40%
22uF	30%	30%

For +15V/-3V configuration without using COUT1_LOAD capacitor the recommended values of COUT2 = 4.7uF and COUT3 = $3 \times 10uF$. By using 10uF as COUT1_LOAD, the value of COUT2 can be reduced to 40% of its original value. COUT2 can be then reduced from 4.7uF to 2.2uF. The minimal ratio of COUT3 to COUT2 has to fulfilled, so the same equation as before applies to COUT3 calculation.

Example

$$c_{out3} = \frac{V_{OUT+}}{V_{OUT-}} \times 1.1 \times COUT2$$

$$c_{out3} = \frac{15VDC}{3VDC} \times 1.1 \times 2.2 \mu F = 12.1 \mu F$$

The closest higher value is 15uF. The number of COUT3 capacitors have been reduced from 3 pieces to 1 piece. In total the design contains 1 capacitor less.

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DEFINING RLIM

When the device has been configured to dual positive or dual negative configuration, set up the RLIM resistor as the maximum load current ($I_{OUT-max}$) needed for V_{OUT-} to COM path using following equation:

Calculation

$$R_{LIM} = \frac{V_{OUT-}}{I_{OUT} - _{max}} - R_{LIM_{internal}}$$

* $R_{LIM internal} = 30\Omega$

* $I_{OUT-_{max}} = depends on application$

Example R_{LIM} for V_{OUT} = 5VDC

$$R_{LIM} = \frac{5V}{12mA} - 30\Omega = 383\Omega$$

* I_{OUT- max} has been defined as 12mA for the target application

When the device has been configured to dual output configuration with one positive and one negative output, set up the RLIM resistor using following equation:

Calculation

$$R_{LIM} = \frac{V_{OUT-}}{38 \times V_{OUT-} \times COUT3 + 0.005} - R_{LIM_internal}$$

Example RLIM for $V_{\text{OUT-}} = 5V$ and COUT3 = 40uF

$$R_{LIM} = \frac{5V}{38 \times 5V \times 0.00004F + 0.005} - 30\Omega = 367\Omega$$

* selected RLIM 10% lower=332 0hm

Note11: The equation assumes 15% tolerance of the COUT3 capacitor and certain response time to transient conditions and load for the driver circuit. Higher value of the limiting resistor can be used in case the power losses have to be minimized. Contact RECOM for further assistance to calculate the right RLIM value for your application.

CONTROL FUNCTION				
Parameter	Condition	Min.	Тур.	Max.
Control Pin Voltage	CTRL pin to PGND	OVDC		5.5VDC
ON/OFF CTRL	rising			2.1VDC
ON/OFF GIRL	falling	0.8VDC		
Input Current	no load			40mA
	full load		190mA	
Input Current of CTRL Pin	V _{CTRL} = 5.0V		5µA	18μΑ

POWER GOOD OPERATING CONDITIONS					
Parameter	Condition	Min.	Тур.	Max.	
PowerGood threshold	PG of negated	90% of V _{FB}		110% of V _{FB}	
PowerGood pin voltage	PG pin to PGND	OVDC		5.5VDC	
Primary side soft start time out	Timer begins when V _{IN} > UVLO and CTRL= High and reset when Powergood pin indicates Good		16ms		

AGND REGULATIONS HYSTERESIS						
Parameter	Condition	Min.	Тур.	Max.		
Feedback regulation reference voltage	AGND to V _{OUT-}	2.4675VDC	2.5VDC	2.5325VDC		
COM pin Short Charge comparator rising threshold to exit PWM	rising		0.73VDC			
On-Time during COM pin Short Charge PWM mode	COM pin < 0.645 VDC, while FBV _{OUT} . pin < 2.48 VDC		1.2µs			
Off-Time during COM pin Short Charge PWM mode	COM pin < 0.645 VDC, while FBV _{OUT} . pin < 2.48 VDC		5µs			

OUTPUT UNDER VOLTAGE LOCKOUT						
Parameter	Condition	Min.	Тур.	Max.		
UVLO rising threshold (V _{OUT+} to V _{OUT-})	Voltage at FBV _{OUT+}		0.9VDC			
UVLO hysteresis (V _{OUT+} to V _{OUT-})	Voltage at FBV _{ouт+}		0.2VDC			

OUTPUT OVER VOLTAGE LOCKOUT					
Parameter	Condition	Min.	Тур.	Max.	
OVLO rising threshold	Voltage from V _{OUT+} to V _{OUT-} , rising	29.45VDC	31VDC	32.55VDC	
OVLO falling threshold	Voltage from V _{OUT+} to V _{OUT-} , falling	27.55VDC	29VDC	30.45VDC	

COMMON MODE TRANSIENT IMMUNITY (CMTI)				
Parameter	Condition	Min.	Тур.	Max.
Common Mode Transient Immunity				±150V/ns

R9C1T18/R Series / Power Module 3W / 8.5V-18VDC / 36 Pin SSOP Package



PROTECTIONS						
Parameter	Condition	Min.	Тур.	Max.		
Over Power Protection (OPP)				latch-off		
Over Temperature Protection ⁽¹²⁾ (OTP)				latch-off		
Over Temperature Shutdown Setpoint			160°C±10°C			
Over Temperature Shutdown Hysteresis	cool down after latch-off before restart is enabled		20°C±5°C			

Note12: The R9C1T18/R integrates power stages with over-temperature protection. If temperatures exceed limits, it stops switching and enters a latch-off protection mode.

Parameter	Condition	Min.	Тур.	Max.
	junction to case		28.5K/W	
Thermal Impedance	junction to board		25.9K/W	
	junction to ambient, refer to "Note7"		52.3K/W	
ESD	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001			±2k\
E9D	Charged-device model (CDM), per JEDEC specification JESD22-C101			±500\
Moisture Sensitive Level			Level 3,	260°C, 168hrs

ISOLATION CAPABILITIES					
Parameter		Condition	Min.	Тур.	Max.
Comparative tracking index (CTI)	DIN	DIN EN 60112 (VDE 0303-11); IEC 60112			600VDC
		Rated mains voltage ≤ 300 VRMS			I-IV
Overvoltage Category		Rated mains voltage ≤ 600 VRMS			I-IV
		Rated mains voltage ≤ 1000 VRMS			-
Isolation Voltage ⁽¹³⁾		tested in qualification			5kVAC/1min.
		tested in production			6kVAC/1sec.
Repetitive peak isolation voltage		AC voltage (bipolar)			1.4kVp
Working isolation voltage	AC volt	age (sine wave) Time dependent dielectric breakdown (TDDB) test			1000VRMS
		DC voltage			1.4kVDC
Transient indiction valters		tested in qualification		7k\	
Transient isolation voltage		tested in production			8.4kVp/1sec.
Impulse voltage		waveform per IEC 62368-1			7.6kVp
Surge isolation voltage		waveform per IEC 62368-1			10kVp
		VIO= 500VDC, TA= 25°C	1000GΩ		
Isolation Resistance	input to output	VIO= 500VDC, 100°C ≤ TA ≤ 125°C	100GΩ		
		VIO= 500VDC at TS= 150°C	1GΩ		
Isolation Capacitance		input to output			3.5pF
Internal Clearance	transformer power isolation		120µm		
Internal Clearance		capacitive signal isolation	15.4µm		
External Clearance			8mm		
External Creepage			8mm		

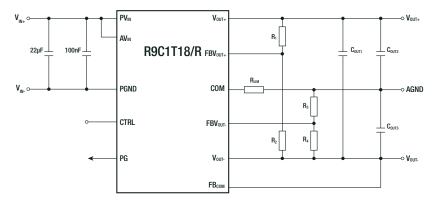
Note13: High voltage isolation testing of a barrier component can degrade isolation capability. RECOM therefore strongly advises against repeated high-voltage isolation testing. If required, reduce specified retest voltage by 20%.

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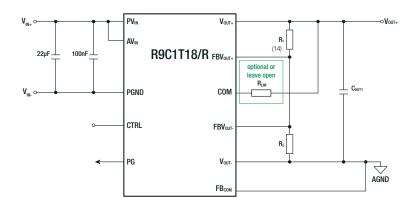


APPLICATION INFORMATION

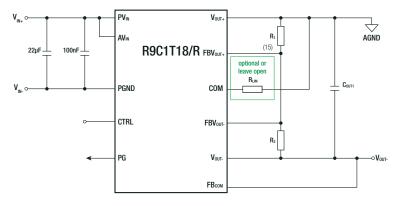
Dual Output (one positive, one negative)



Single Output (positive)

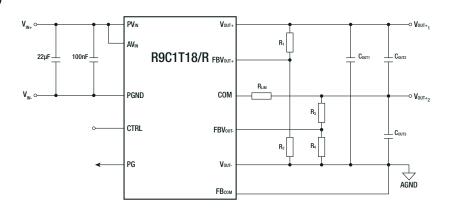


Single Output (negative)



Note14: Use RLIM only for very low load cases (<15mA) and when very high switching frequency is used (>250kHz) the RLIM value should be at least $1k\Omega$.

Dual Output (both positive)

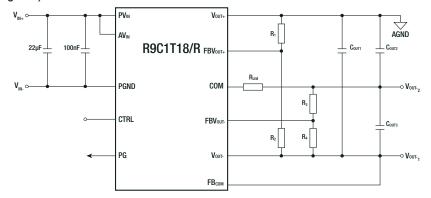


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APPLICATION INFORMATION

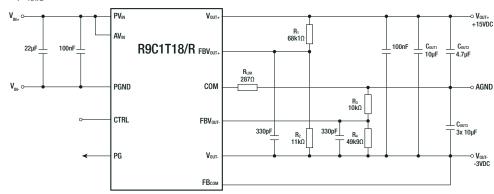
Dual Output (both negative)



APPLICATION EXAMPLES

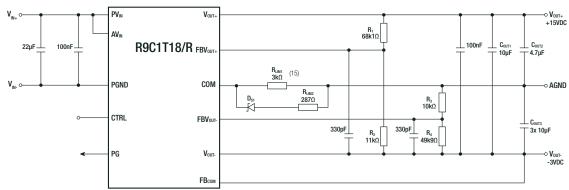
Dual Output (one positive, one negative)

 $V_{OUT+} = 15VDC$, $V_{OUT-} = 3VDC$, $V_{TOTAL} = 18VDC$



Dual Output (one positive, one negative) - RDR configuration

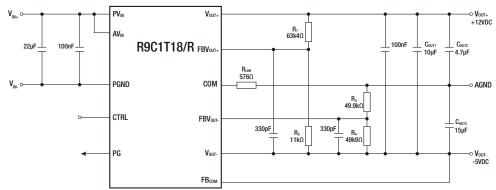
 $V_{OUT+} = 15VDC$, $V_{OUT-} = 3VDC$, $V_{TOTAL} = 18VDC$



Note15: Using a Schottky diode and a resistor in paralel with a resistor allows programming the charge and discharge current independently. This RDR configuration greatly reduces power losses of the device.

Dual Output (one positive, one negative)

 $V_{OUT+} = 12VDC$, $V_{OUT-} = 5VDC$, $V_{TOTAL} = 17VDC$



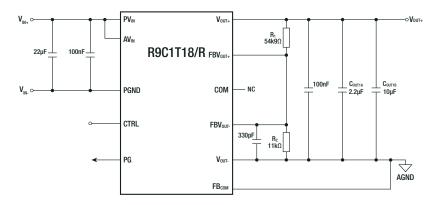
3W / 8.5V-18VDC / 36 Pin SSOP Package



APPLICATION EXAMPLES

Single Output (positive)

 $V_{\text{OUT}} = 15 \text{VDC}$

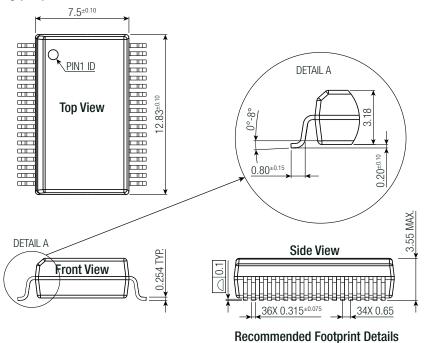


DIMENSION & PHYSICAL CHARACTERISTICS					
Parameter	Туре	Value			
Dimension (LyMM)		12.83 x 7.5 x 3.55mm			
Dimension (LxWxH)		0.51 x 0.30 x 0.14 inch			
Walaht		0.1g typ.			
Weight		0.0032 oz			

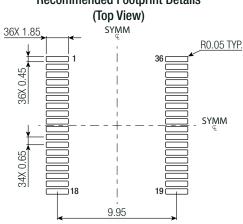
Dimension Drawing (mm)







10.30±0.33 18 19 Bottom View



3W / 8.5V-18VDC / 36 Pin SSOP Package



DIMENSION & PHYSICAL CHARACTERISTICS

Pad Information

Pad #	Function	Description
1, 2, 5, 8, 9, 10,		
11, 12, 13, 14,	PGND	Primary side power ground. Place several vias to copper pours for thermal relief.
15, 16, 17, 18		
3	PG	Power good open-drain output. Low when UVLO, OVLO, UVP, OVP, and OTP are not triggered.
4	CTRL	Pull high to enable the device. Connect to ground to disable the device.
6	AV _{IN}	Primary side analog input. Connect a 330pF ceramic capacitor between AV _N and pin 5. Connect pin6 to pin7.
7	PV _{IN}	Primary side power input. Connect a 0.1μF and a 22μF ceramic capacitor to pin 8.
19, 20, 21, 22,		
23, 24, 25, 26,	$V_{\text{OUT-}}$	Secondary side negative output voltage.
27, 30, 31, 36		
28, 29	$V_{\text{OUT+}}$	Secondary side positive output voltage. Connect a $10\mu F$ and $0.1\mu F$ ceramic capacitor between V_{OUT+} and V_{OUT-}
32	COM	Connect current limiting resistor to COM node of circuit. See application example or "Defining RLIM" section.
33	FBV _{OUT} -	FBV_{OUT} Feedback (COM $-V_{OUT}$) output voltage sense pin used to set the output (COM $-V_{OUT}$) voltage.
34	FBV _{out+}	$FBV_{OUT} \ Feedback \ (V_{OUT+} - V_{OUT-}) \ output \ voltage \ sense \ pin \ used \ to \ set \ the \ output \ (V_{OUT+} - V_{OUT-}) \ voltage.$
35	FB _{COM}	Use as reference for FBV _{OUT+} and FBV _{OUT-} .

LAYOUT GUIDELINES

The R9C1T18/R integrated isolated power solution simplifies system design and reduces board area usage. Follow these guidelines for proper PCB layout to achieve optimal performance:

- Place decoupling capacitors as close as possible to the device pins. On the primary side, place the capacitors between pin 7 (power V_{IN}) and pins 8−18 (power GND). Optionally, place a capacitor between pin 6 (analog V_{IN}) and pins 1, 2, and 5 (analog GNDP). Always put lower values and smaller packages as close to the IC pins as possible.
- For the isolated secondary side, place the capacitors between pin 28, 29 (V_{OUT+}) and pins 19–25, 30–31, 35–36 (V_{OUT-}). Put capacitors between V_{OUT+} and V_{OUT-} close to the IC.
- The capacitors between V_{OUT+}/COM and COM/V_{OUT-} should be placed near the output device (gate driver input).
- Connection of Feedback circuit to FBCOM (pin 35) should be separated from V_{OUT}. plane. Use one short trace to connect this pin to the feedback low-side resistors. Place FB resistors and capacitors close to each other and close to the IC.
- Separate the traces from the COM pin and the FB_{Vout}- pin while routing. If possible, use a via near the FB_{Vout}- pin to route the feedback connection through a different layer.
- Sense connections should be connected to the capacitors at the output device (gate drivers).
- The package of the module dissipates heat through the GNDP and V_{OUT}. pins. Ensure sufficient copper around the IC, preferably connected to the ground plane through multiple vias, is present on the GNDP and V_{OUT}. pins. A minimum of four layers and using 2oz copper in internal layers are recommended for optimal thermal PCB design.
- We recommend connecting the V_{IN} , GND, V_{OUT+} , and V_{OUT-} pins to internal ground or power planes through multiple vias. Alternatively, make the traces connected to these pins as wide as possible to minimize losses.
- Pay close attention to the spacing between the primary side and the output signals on the outer layers of the PCB. The effective creepage and clearance of the system are reduced if the gap between the primary and isolated sides is smaller than that of the R9C1T18/R package pins. Avoid placing any traces under the module.

3W / 8.5V-18VDC / 36 Pin SSOP Package



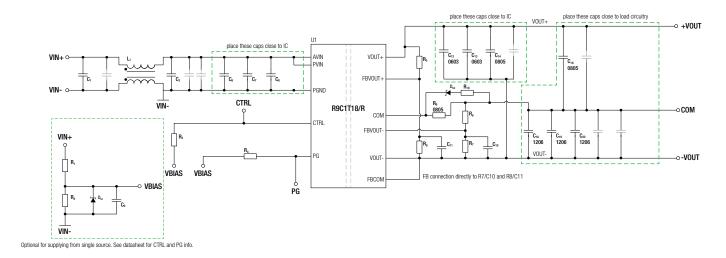
EMC FILTERING SUGGESTIONS ACCORDING TO EN55032

The successful EMC filtering of the R9C1T18/R requires the selection of suitable components, correct PCB layout, and mechanical shielding of the application where the module is used. Here are some additional notes for the PCB layout:

- Optionally, inner layers can be used to create a high-frequency bypass capacitor between GNDP and VOUT- to mitigate radiated emissions.
 Overlapping these layers can be beneficial for reducing radiated emissions. However, this solution might not be suitable for applications requiring fast dV/dt switching. Suitable core thickness and material can help set the correct minimum allowed capacitance between primary and secondary side.
- If the isolation requirements permit, place the internal ground power plane (GNDP) under the module package area. This can serve as partial shielding for the device, helping to reduce radiated emissions.
- If the primary side and isolated secondary output ground planes cannot overlap (as per previous notes), mechanical shielding may be necessary to meet EN55032 Class B requirements. We recommend connecting the metal shielded box to the primary GND.

DESIGN & LAYOUT EXAMPLE

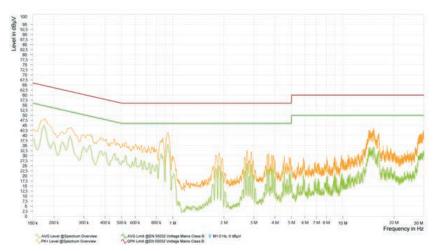
This design is created for application with supply 8,5-18VIN and +15/-3V Output voltage.



Note16: For different Output Voltage levels and setting correct resistor values

Spectrum Overview

Common mode LISN 15VIN, Full Load



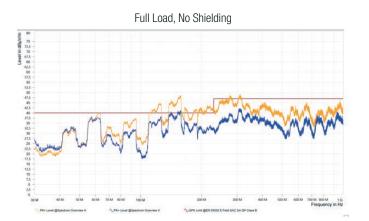
3W / 8.5V-18VDC / 36 Pin SSOP Package

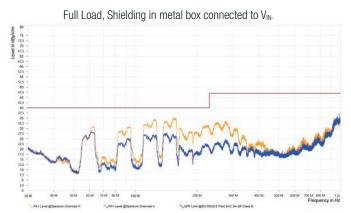


DESIGN & LAYOUT EXAMPLE

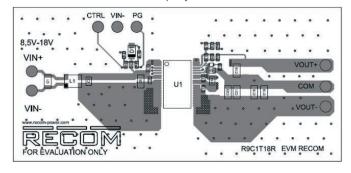
Radiated Emissions

Common mode LISN 15VIN, Full Load

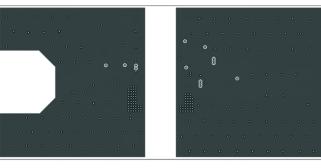




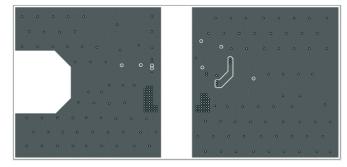
Top Layer



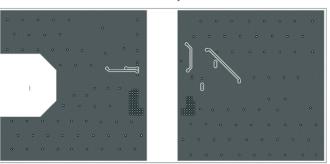
Inner Layer 1



Inner Layer 2



Bottom Layer



3W / 8.5V-18VDC / 36 Pin SSOP Package



BOM

Designator	Description	
C1, C6, C18, C19, C20	CAP, CER,X7R,10UF,50VDC,-10%,+10%,1206	
C7, C9, C13	CAP,CER,X7R,100NF,100VDC,-10%,+10%,0603, CAP	
C8, C10, C11	CAP,CER,X7R,330PF,50VDC,-10%,+10%,0603	
C12	CAP,CER,C0G/NPO,100PF,50VDC,-5%,+5%,0603	
C3, C14	CAP,CER,X7R,2.2UF,50VDC,-10%,+10%,0805	
C16	CAP,CER,X7R,4.7UF,50VDC,-10%,+10%,0805	
D1	DIODE ZENER 5.1V 500MW SOD123	
D2	DIODE SCHOTTKY 30V SOD523	
L1	SMT Common Mode Line Filter 1uH 1.2A 1812	
R1, R4	RES,DIS,THICK,100K,0.1W,1%,100PPM,0603	
R2	RES,DIS,THIN,39K,0.1W,0.1%,25PPM,0603	
R3	RES,DIS,THICK,4K7,0.1W,1%,100PPM,0603	
R5	RES,DIS,THICK,68K1,0.1W,1%,100ppm,0603	
R6	RES,DIS,THICK,10K,0.1W,1%,100ppm,0603	
R7	RES,DIS,THICK,49K9,0.1W,1%,100ppm,0603	
R8	RES,DIS,THICK,11K,0.1W,1%,100ppm,0603	
R9	RES,DIS,THICK,220R,0.125W,1%,100ppm,0805	
R10	RES,DIS,THICK,47R,0.1W,1%,100ppm,0603	
U1	R9C1T18 1W, Isolated DCDC	

Parameter	Ту	rpe	Value
Declaring Discouries (LyMMd)	Suffix -R: tape and reel	reel diameter + width	330.2mm + 24.4mm height 13inch + 0.96inch height
Packaging Dimension (LxWxH)	Suffix -CT: mois	sture barrier bag	100 x 150 x 30 mm 3.94 x 5.90 x 1.18 inch
Deckering Quantity	Suffix -R: tape and ree		750pcs
Packaging Quantity	Suffix -CT: mois	sture barrier bag	10pcs
Storage Temperature Range			-40°C to +125°C
Storage Humidity	non-cor	ndensing	5% - 95% RH max.

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MGN1S0508MC-R7 MGN1S0512MC-R7 MGN1S1208MC-R7 MGN1S1212MC-R7 PESE1-S3-S24-M R05C1TF05S-CT R05C1TF05S-R

R12C2T12/R-CT R12C2T12/R-R R12C2T25/R-CT R12C2T25/R-R R15C2T25/R-CT R15C2T25/R-R R1M-1205S/SMD R1M-2412D/SMD

R1M-2412S/SMD R1M-2415D/SMD R24C2T25-CT R24C2T25-R R24C2T25/R-CT R24C2T25/R-R R2M-1205S/SMD R2M-2405S/SMD

R2M-2412D/SMD R2M-2412S/SMD R2M-2415D/SMD R3M-1205S/SMD R3M-2405S/SMD R3M-2412D/SMD R3M-2412S/SMD R3M-2412S/SMD R3M-2415D/SMD R5M-2415D/SMD R5M-2415D/SMD R5M-2415D/SMD R5M-2415S/SMD R5M-2415S/SMD R5M-2415S/SMD R5M-2415D/SMD R5M-2415D/SMD R5M-2415S/SMD R9C1T18/R-CT R9C1T18/R-R

RA3-241503D/SMD REM2A-0505S/SMD REM2A-0512S/SMD REM2A-1205S/SMD